



## 150V N-Channel Trench Power MOSFET

### General Description

The SJA015N2200 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

### Features

- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

### Application

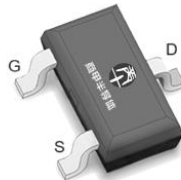
- Power switching application
- Hard switched and high frequency circuits

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	150	V
$R_{DS(ON\_TYP)}$	225	mΩ
$I_D$	2	A
$Q_G$	16	nC



Schematic Diagram



SOT-23-3L top view



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Reel Size	Tape width	Quantity
SJA015N2200	1502	SOT-23-3L	\	\	2500

Table 1. Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	150	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^\circ\text{C}$ )	2	A
	Drain Current-Continuous( $T_A=100^\circ\text{C}$ )	1.2	A
$I_{DM}$ (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	8	A
$P_D$	Maximum Power Dissipation( $T_A=25^\circ\text{C}$ )	2.4	W
	Maximum Power Dissipation( $T_A=100^\circ\text{C}$ )	0.96	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		52	$^\circ\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	150			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =150V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃			1	μA
		V <sub>DS</sub> =150V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1		3	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =2A		4.5		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =2A T <sub>J</sub> =25℃		225	270	mΩ
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		733		pF
C <sub>oss</sub>	Output Capacitance			13.5		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			5		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		1.4		Ω
Switching Parameters						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =75V, R <sub>L</sub> =25Ω, R <sub>GEN</sub> =6Ω		9		nS
t <sub>r</sub>	Turn-on Rise Time			11		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			24		nS
t <sub>f</sub>	Turn-Off Fall Time			8		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =75V, I <sub>D</sub> =3A		16		nC
Q <sub>gs</sub>	Gate-Source Charge			2.1		nC
Q <sub>gd</sub>	Gate-Drain Charge			6.4		nC
Source-Drain Diode Characteristics						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				2	A
V <sub>SD</sub>	Forward on Voltage <sup>(Note 3)</sup>	V <sub>GS</sub> =0V, I <sub>S</sub> =3A			1.2	V

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

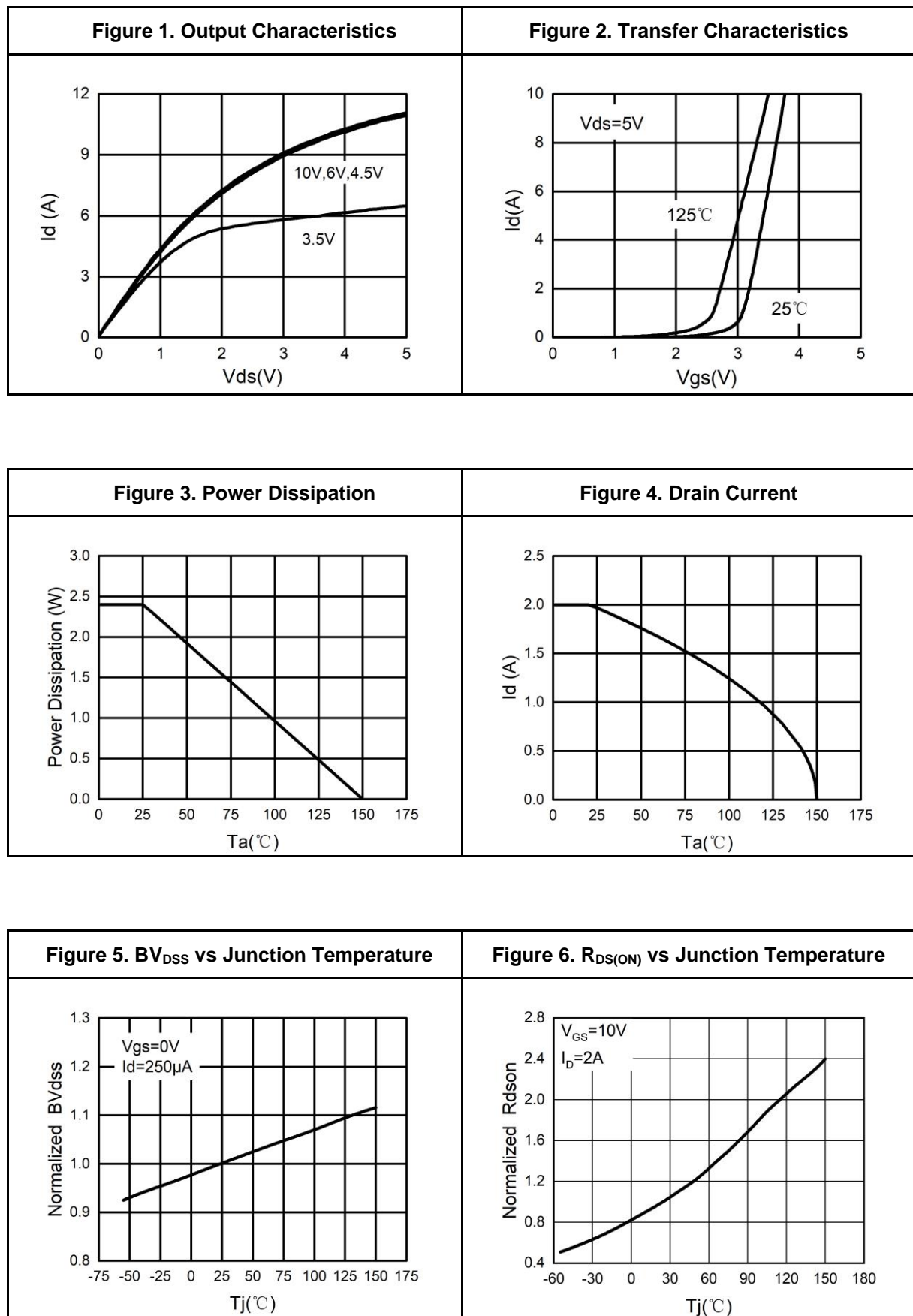
Notes 2.EAS condition:  $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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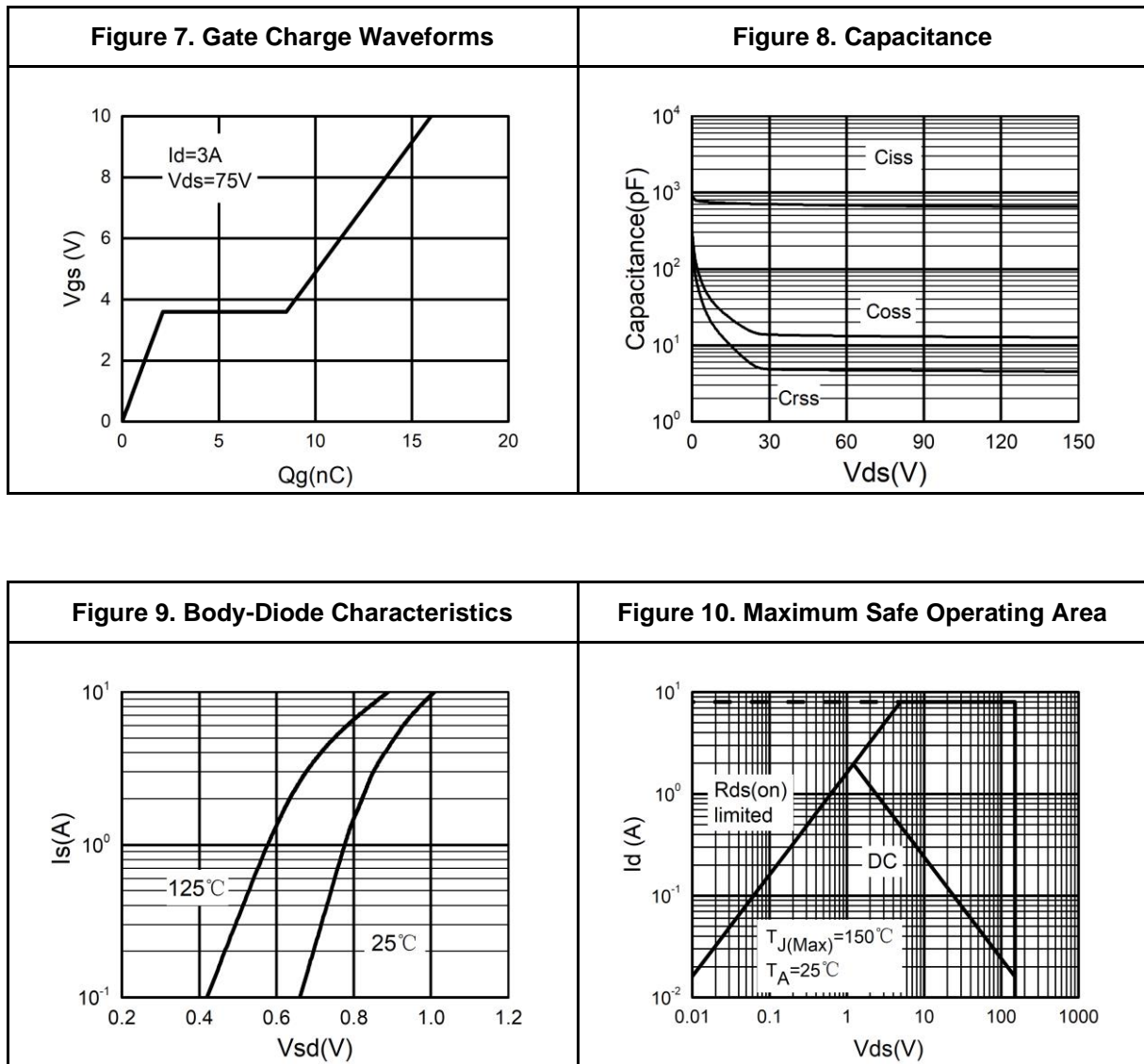
### Typical Electrical And Thermal Characteristics (Curves)





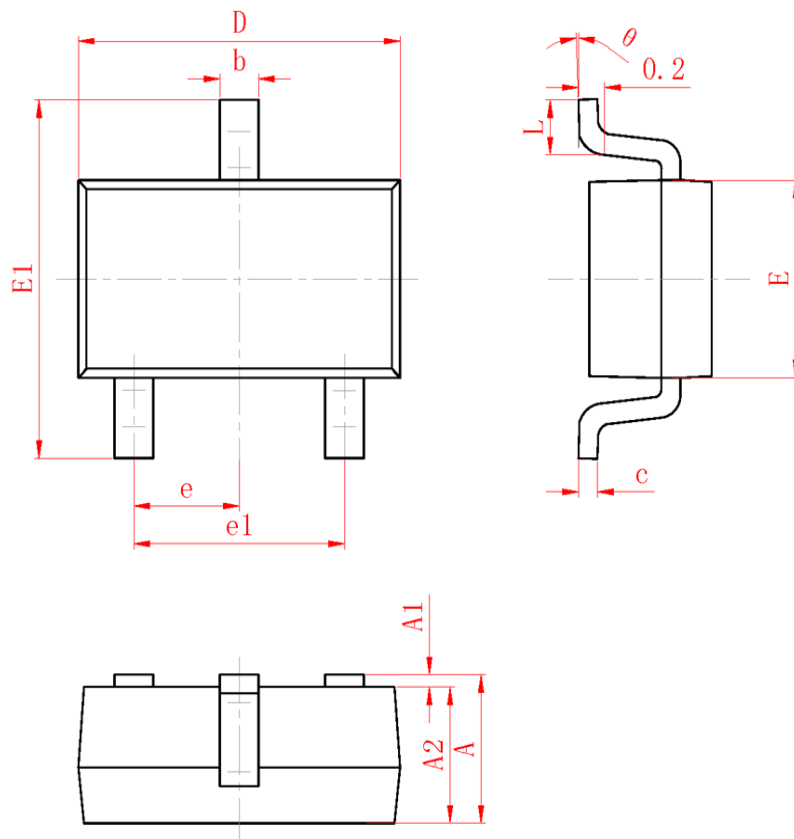
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### Typical Electrical And Thermal Characteristics (Curves)





SOT-23-3L Package Information



SYMBOL	MILLIMETER	
	MIN	MAX
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.250	0.450
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950 (BSC)	
e1	1.800	2.000
L	0.300	0.500
$\theta$	0°	8°

Symbol	Dimensions In Millimeters	
	Min.	Max.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.250	0.450
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950(BSC)	
e 1	1.800	2.000
L	0.300	0.500
$\theta$	0°	8°



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